RS-232/RS-485/RS-422 TRANSCEIVER WITH INTERNAL TERMINATION

OCT 2011 REV. 1.0.0

GENERAL DESCRIPTION

The SP339 is an advanced multiprotocol transceiver supporting RS-232, RS-485, and RS-422 serial standards in a 40 pin QFN package. Integrated cable termination and four configuration modes allow all three protocols to be used interchangeably over a single cable or connector with no additional switching components. Full operation requires only four external charge pump capacitors.

The RS-485/422 modes feature one driver and one receiver (1TX/1RX) in both half and full duplex configurations. The RS-232 mode (3TX/5RX) provides full support of all eight signals commonly used with the DB9 RS-232 connector. A dedicated diagnostic loopback mode is also provided.

The high speed drivers operate up to 20Mbps in RS-485/422 modes, and up to 1Mbps in RS-232 mode. All drivers can be slew limited to 250kbps in any mode to minimize electromagnetic interference (EMI).

All transmitter outputs and receiver inputs feature robust electrostatic discharge (ESD) protection to ±15kV Human Body Model (HBM) and ±8kV IEC-61000-4-2 Contact. Each receiver output has full fail-safe protection to avoid system lockup, oscillation, or indeterminate states by defaulting to logic-high output level when the inputs are open, shorted, or terminated but undriven. No external biasing resistors are required.

The RS-232 receiver inputs include a $5k\Omega$ pull-down to ground. The RS-485/422 receiver inputs are high impedance (>96k Ω when termination is disabled), allowing up to 256 devices on a single communication bus (1/8th unit load).

The SP339E operates from a single power supply, either 3.3V or 5V, with low idle current (2mA typical in all modes). The shutdown mode consumes less than 10µA for low power standby operation.

FEATURES

- Pin selectable Cable Termination
- No external resistors required for RS-485/422 termination and biasing
- 3.3V or 5V Single Supply Operation
- Robust ESD Protection on bus pins
 - ±15kV Human Body Model (HBM)
 - ±8kV IEC 61000-4-2 (Contact)
- Max Data Rate of 20Mbps in RS-485/422 Modes and up to 1Mbps in RS-232 Modes
- Pin selectable 250kbps Slew Limiting
- 3 Drivers, 5 Receivers RS-232/V.28
- 1 Driver, 1 Receiver RS-485/422
 - Full and Half Duplex Configuration
 - 1/8th Unit Load, up to 256 receivers on bus
- RS-485/422 Enhanced Failsafe for open, shorted, or terminated but idle inputs
- Space saving 6mm x 6mm QFN-40 Package
- Pin compatible with SP338E

TYPICAL APPLICATIONS

- Dual Protocol Serial Ports (RS-232 or RS-485/422)
- Industrial Computers
- Industrial and Process Control Equipment
- Point-Of-Sale Equipment
- Networking Equipment
- HVAC Controls Equipment
- Building Security and Automation Equipment

ORDERING INFORMATION

PART NUMBER	Package	OPERATING TEMPERATURE RANGE	DEVICE STATUS
SP339EER1-L	40-pin QFN	-40°C to +85°C	Active
SP339EER1-L/TR	40-pin QFN	-40°C to +85°C	Active
SP339ECR1-L	40-pin QFN	0°C to +70°C	Active
SP339ECR1-L/TR	40-pin QFN	0°C to +70°C	Active

ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections to the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability and cause permanent damage to the device.

Supply Voltage V _{CC}	-0.3V to +6.0V				
Receiver Input Voltage (from Ground)	±20V				
Driver Output Voltage (from Ground)	±20V				
Short Circuit Duration, TX out to Ground	Continuous				
Voltage at TTL Input Pins	-0.3V to V _{CC} +0.5V				
Storage Temperature Range	-65°C to +150°C				
Lead Temperature (soldering, 10s)	+300°C				
Power Dissipation 40-pin QFN (derate 17mW/°C above +70°C)	500mW				

CAUTION:

ESD (ElectroStatic Discharge) sensitive device. Permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. Personnel should be properly grounded prior to handling this device. The protective foam should be discharged to the destination socket before devices are removed.

ESD PROTECTION

		MIN.	TYP.	Max.	Units	
R1-R9	R1-R9 Tx Output & Rx Input Pins		±15		kV	Human Body Model (HBM)
1(1-1(3)			±8		kV	IEC 61000-4-2 (Contact)
	All Other Pins		±2		kV	Human Body Model (HBM)



PIN DESCRIPTIONS BY MODE (MODE1, MODE0)

Pin	Name	00, Figure 1	00, Figure 1 01, Figure 2		11, Figure 4			
1	L1	R1 0	utput	1	1			
2	L2	R2 O	utput	R1 Output	R1 Output			
3	L3	T1 lı	nput	T1 Input	T1 Input			
4	L4	T2 lı	nput					
5	L6	R3 O	utput	1	1			
6	L7	T3 lı	nput					
7	L8	R4 O	utput	1	1			
8	L9	R5 O	utput	1	1			
9	VCC	V _{CC}						
10	GND	Ground						
11	SLEW		SLEW = \	CC enables 250kbps slew limiting				
12	DIR1			T1 Enable, R1 Disable	T1 Enable			
13	N/C	Т	his pin is not used and	is disconnected internal	ly			
14	MODE0	0	1	0	1			
15	MODE1	0	0	1	1			
16	N/C	This pin is not used and is disconnected internally						
17	TERM		Enables RS-485/422 re					
18	N/C	This pin is not used and is disconnected internally						
19	ENABLE	ENAB	BLE = V _{CC} for operation	, ENABLE = 0V for shut	tdown			
20	VCC		V	СС				



PIN DESCRIPTIONS BY MODE (MODE1, MODE0)

Pin	Name	00, Figure 1	01, Figure 2	11, Figure 4						
21	R9		R5 Input							
22	R8									
23	GND		Gr	ound						
24	R7		T3 Output							
25	R6		R3 Input							
26	GND		Gr	round						
27	R4		T2 Output							
28	R3		T1 Output							
29	GND		Ground							
30	R2		R2 Input	R1 Input A, T1 Out A	T1 Out A					
31	R1		R1 Input	R1 Input B, T1 Out B	T1 Out B					
32	VCC		\	V _{CC}						
33	VSS	V_{SS} - Charge pump negative supply, $0.1 \mu F$ from ground								
34	C2-		C ₂₊ - Charge pum	p cap 2 negative lead						
35	C1-		C ₁₋ - Charge pum	p cap 1 negative lead						
36	GND		Gr	ound						
37	C1+		C ₁₊ - Charge pump c	ap 1 positive lead, 0.1μF						
38	VCC		V _{CC}							
39	C2+		C ₂₊ - Charge pump c	ap 2 positive lead, 0.1μF						
40	VDD	V _D	_D - Charge pump posi	tive supply, 0.1μF to groun	d					



ELECTRICAL CHARACTERISTICS

UNLESS OTHERWISE NOTED:

 V_{CC} = +3.3V ±5% or +5.0V ±5%, C1-C4 = 0.1 μ F; T_A = T_{MIN} to T_{MAX} . Typical values are at V_{CC} = 3.3V, T_A = +25°C.

SYMBOL	PARAMETERS MIN. TYP. M		Max.	Units	CONDITIONS	
DC CHARAC	CTERISTICS					
I _{CC}	Supply Current (RS-232)		2	8	mA	No load, idle inputs
I _{CC}	Supply Current (RS-485)		2	8	mA	No load, idle inputs
I _{CC}	Vcc Shutdown Current		1	10	μА	ENABLE = 0V
TRANSMITT	ER and LOGIC INPUT PINS: Pins 3, 4,	6, 11, 12	2, 14, 15	, 17-19		
V _{IH}	Logic Input Voltage High	2.0			V	V _{CC} = 3.3V
V _{IH}	Logic Input Voltage High	2.4			V	V _{CC} = 5.0V
V _{IL}	Logic Input Voltage Low			0.8	V	
I _{IL}	Logic Input Leakage Current Low			1	μА	Input Low (V _{IN} = 0V)
I _{IH}	Logic Input Leakage Current High			1	μА	Input High (V _{IN} = V _{CC}), pins 3, 4 and 6
I _{PD}	Logic Input Pull-down Current			50	μА	Input High (V _{IN} = V _{CC}), pins 11, 12, 14, 15, 17-19
V _{HYS}	Logic Input Hysteresis		200		mV	
RECEIVER (OUTPUTS: Pins 1, 2, 5, 7, 8					
V _{OH}	Receiver Output Voltage High	V _{CC} -0.6			V	I _{OUT} = -1.5mA
V _{OL}	Receiver Output Voltage Low			0.4	V	I _{OUT} = 2.5mA
I _{OSS}	Receiver Output ShortCircuit Current		±20	±60	mA	$0 \leq V_O \leq V_{CC}$
l _{OZ}	Receiver Output Leakage Current		±0.1	±1	μА	$0 \le V_O \le V_{CC,}$ Receivers disabled



ELECTRICAL CHARACTERISTICS (Continued)

UNLESS OTHERWISE NOTED:

 V_{CC} = +3.3V ±5% or +5.0V ±5%, C1-C4 = 0.1µF; T_A = T_{MIN} to T_{MAX} . Typical values are at V_{CC} = 3.3V, T_A = +25°C.

SYMBOL	PARAMETERS	Min.	TYP.	Max.	Units	Conditions
SINGLE-EN	DED RECEIVER INPUTS (RS-232)					
V _{IN}	Input Voltage Range	-15		+15	V	
V _{IL}	Input Threshold Low	0.6	1.2		V	V _{CC} = 3.3V
¥ IL	input Threshold Low	0.8	1.5		V	V _{CC} = 5.0V
V _{IH}	Input Threshold High		1.5	2.0	V	V _{CC} = 3.3V
VIН	input micshold mgn		1.8	2.4	V	V _{CC} = 5.0V
V _{HYS}	Input Hysteresis		0.3		V	
R _{IN}	Input Resistance	3	5	7	kΩ	$-15V \le V_{IN} \le +15V$
SINGLE-EN	DED DRIVER OUTPUTS (RS-232)					
Vo	Output Voltage Swing	±5.0	±5.5		V	Output loaded with $3k\Omega$ to Gnd
	Super voluge oming			±7.0	V	No load output
I _{SC}	Short Circuit Current			±60	mA	V _O = 0V
R _{OFF}	Power Off Impedance	300	10M		Ω	V_{CC} = 0V, V_{O} = ±2V



ELECTRICAL CHARACTERISTICS (Continued)

UNLESS OTHERWISE NOTED: V_{CC} = +3.3V ±5% or +5.0V ±5%, C1-C4 = 0.1 μ F; T_A = T_{MIN} to T_{MAX} . Typical values are at V_{CC} = 3.3V, T_A = +25°C.

SYMBOL	PARAMETERS MIN. TYP. MAX. UNITS		CONDITIONS			
DIFFERENT	IAL RECEIVER INPUTS (RS-485 / RS-4	122)				
R _{IN}	Receiver Input Resistance	96			kΩ	TERM = $0V$, $-7V \le V_{IN} \le +12V$
V_{TH}	Receiver Differential Threshold Voltage	-200	-125	-50	mV	
ΔV_{TH}	Receiver Input Hysteresis		25		mV	V _{CM} = 0V
I _{IN}	Pacaivar Innut Current			125	μА	V _{IN} = +12V
'IN	Receiver Input Current			-100	μА	V _{IN} = -7V
R _{TERM}	Termination Resistance	mination Resistance 100 120 155 O		TERM = V_{CC} , Figure 5 -7V $\leq V_{CM} \leq +12V$		
R _{TERM}	Termination Resistance	100	120	140	Ω	TERM = V_{CC} , Figure 5 $V_{CM} = 0V$
DIFFERENT	IAL DRIVER OUTPUTS (RS-485 / RS-4	22)				
		2		V _{CC}	V	$R_L = 100\Omega$ (RS-422), Figure 6
V_{OD}	Differential Driver Output	1.5		V _{CC}	V	$R_L = 54\Omega$ (RS-485), Figure 6
VOD	Dillerential Driver Output	1.5		V _{CC}	V	V _{CM} = -7V, Figure 7
		1.5		V _{CC}	V	V _{CM} = +12V, Figure 7
ΔV_{OD}	Change In Magnitude of Differential Output Voltage	-0.2		+0.2	V	$R_L = 54\Omega$ or 100Ω , Figure 6
V_{CM}	Driver CommonMode Output Voltage			3	V	R_L = 54Ω or 100Ω, Figure 6
ΔV_{CM}	Change In Magnitude of Common Mode Output Voltage			0.2	٧	$R_L = 54\Omega$ or 100Ω , Figure 6
I _{OSD}	Driver Output Short Circuit Current			±250	mA	-7V ≤ V _O ≤ +12V, Figure 8
I _O	Driver Output Leakage Current			±100	μА	DIR1 = 0V in Mode 11, or ENABLE = 0V, $-7V \le V_O \le +12V$



TIMING CHARACTERISTICS

UNLESS OTHERWISE NOTED:

 V_{CC} = +3.3V ±5% or +5.0V ±5%, C1-C4 = 0.1 μ F; T_A = T_{MIN} to T_{MAX} . Typical values are at V_{CC} = 3.3V, T_A = +25 $^{\circ}$ C.

SYMBOL	PARAMETERS	MIN.	TYP.	Max.	Units	CONDITIONS
ALL MODES						
t _{ENABLE}	Enable from Shutdown		1000		ns	
t _{SHUTDOWN}	Enable to Shutdown		1000		ns	
RS-232, DAT	A RATE = 250kbps (SLEW = Vcc), ON	IE TRAN	SMITTE	R SWITC	HING	
	Maximum Data Rate	250			kbps	$R_L = 3k\Omega, C_L = 1000pF$
t _{RHL} , t _{RLH}	Receiver Propagation Delay		100		ns	C ₁ = 150pF, Figure 9
t _{RHL} -t _{RLH}	Receiver Propagation Delay Skew			100	ns	o_ roopr, rigaro o
t _{DHL} , t _{DLH}	Driver Propagation Delay		1400		ns	$R_L = 3k\Omega, C_L = 2500pF,$
t _{DHL} -t _{DLH}	Driver Propagation Delay Skew			600	ns	Figure 10
		•				
t _{SHL,} t _{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	4		30	V/μs	V_{CC} = 3.3V, R_L = 3k Ω to 7k Ω , C_L = 150pF to 2500pF, Figure 10
t _{SHL} , t _{SLH} Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V		6		30	V/μs	V_{CC} = 3.3V, R_L = 3k Ω to 7k Ω , C_L = 150pF to 2500pF, T_A = 25°C, Figure 10
RS-232, DAT	A RATE = 1Mbps (SLEW = 0V), ONE	TRANSM	ITTER S	WITCHI	NG	
	Maximum Data Rate	1			,	$R_L = 3k\Omega$, $C_L = 250pF$
t _{RHL} , t _{RLH}	Receiver Propagation Delay		100		ns	O 450-5 Figure 0
t _{RHL} -t _{RLH}	Receiver Propagation Delay Skew			100	ns	C _L = 150pF, Figure 9
t _{DHL} , t _{DLH}	Driver Propagation Delay		300		ns	$R_L = 3k\Omega, C_L = 1000pF,$
t _{DHL} -t _{DLH}	Driver Propagation Delay Skew			150	ns	Figure 10
		···			•	
t _{SHL,} t _{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	15		150	V/μs	V_{CC} = 3.3V, R_L = 3k Ω to 7k Ω , C_L = 150pF to 1000pF, Figure 10
t _{SHL,} t _{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	24		150	V/μs	V_{CC} = 3.3V, R_L = 3k Ω to 7k Ω , C_L = 150pF to 1000pF, T_A = 25°C, Figure 10



TIMING CHARACTERISTICS (Continued)

UNLESS OTHERWISE NOTED: V_{CC} = +3.3V ±5% or +5.0V ±5%, C1-C4 = 0.1 μ F; T_A = T_{MIN} to T_{MAX} . Typical values are at V_{CC} = 3.3V, T_A = +25°C.

SYMBOL	PARAMETERS	MIN.	TYP.	Max.	Units	CONDITIONS	
RS-485/RS-42	2, DATA RATE = 250kbps (SLEW = V	/cc), ONE	TRANS	MITTER	SWITC	HING	
	Maximum Data Rate	250			kbps	$R_L = 54\Omega$, $C_L = 50pF$	
t _{RPHL} , t _{RPLH}	Receiver Propagation Delay		50	150	ns	C ₁ = 15pF, Figure 11	
t _{RPHL} -t _{RPLH}	Receiver Propagation Delay Skew			20	ns		
t _{DPHL} , t _{DPLH}	Driver Propagation Delay		500	1000	ns	D 540 0 50 5	
t _{DPHL} -t _{DPLH}	Driver Propagation Delay Skew			100	ns	$R_L = 54\Omega$, $C_L = 50pF$, Figure 12	
$t_{DR,} t_{DF}$	Driver Rise and Fall Time	300	650	1200	ns	1 19010 12	
t_{RZH} , t_{RZL}	Receiver Output Enable Time			200	ns	Figure 13	
t_{RHZ} , t_{RLZ}	Receiver Output Disable Time			200	ns	Tigure 10	
t _{DZH} , t _{DZL}	Driver Output Enable Time			1000	ns	Figure 14	
t _{DHZ} , t _{DLZ}	Driver Output Disable Time	bisable Time 200 n		ns	Tigure 14		
RS-485/RS-42	2, DATA RATE = 20Mbps (SLEW = 0'	V), ONE	TRANSM	IITTER S	WITCH	ING	
	Maximum Data Rate	20			Mbps	$R_L = 54\Omega$, $C_L = 50pF$	
t _{RPHL} , t _{RPLH}	Receiver Propagation Delay		50	150	ns	C _L = 15pF, Figure 11	
t _{RPHL} -t _{RPLH}	Receiver Propagation Delay Skew			10	ns	C _L = 15pr, Figure 11	
t _{DPHL} , t _{DPLH}	Driver Propagation Delay		30	100	ns		
t _{DPHL} -t _{DPLH}	Driver Propagation Delay Skew			10	ns	$R_L = 54\Omega$, $C_L = 50pF$, Figure 12	
t _{DR} , t _{DF}	Driver Rise and Fall Time		10	20	ns	Tigure 12	
		•	•	•	•		
t_{RZH} , t_{RZL}	Receiver Output Enable Time			200	ns	Figure 13	
t _{RHZ} , t _{RLZ}	Receiver Output Disable Time			200	ns	Tigule 10	
t _{DZH} , t _{DZL}	Driver Output Enable Time			200	ns	Figure 14	
touz touz	DHZ, t _{DLZ} Driver Output Disable Time			200 ns		Figure 14	



BLOCK DIAGRAM BY MODE (MODE1, MODE0)

FIGURE 1. MODE 00 - LOOPBACK

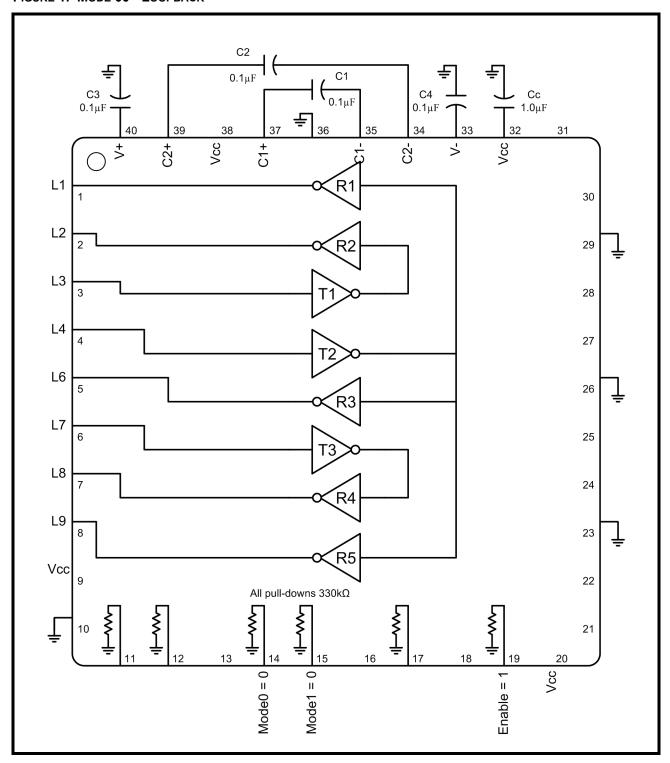




FIGURE 2. MODE 01 - RS-232

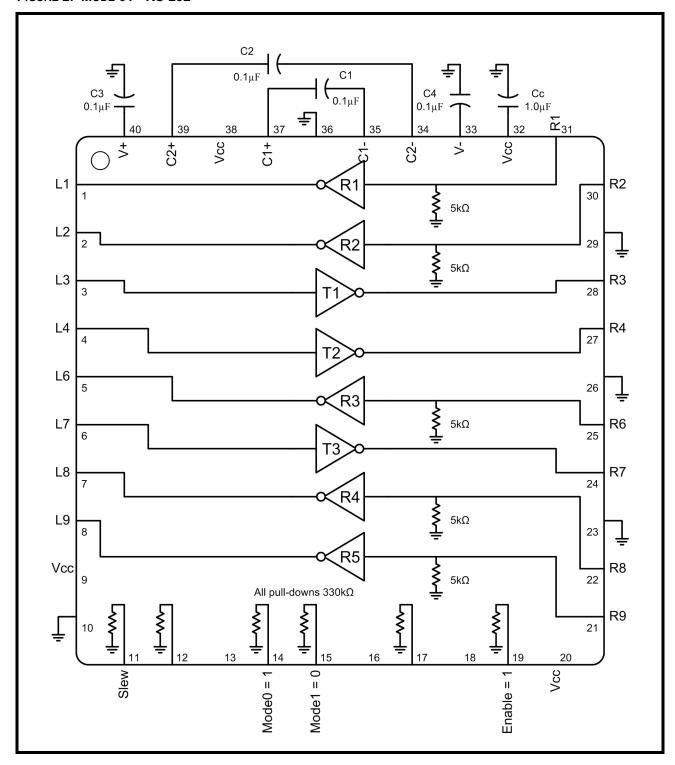




FIGURE 3. MODE 10 - RS-485 HALF DUPLEX

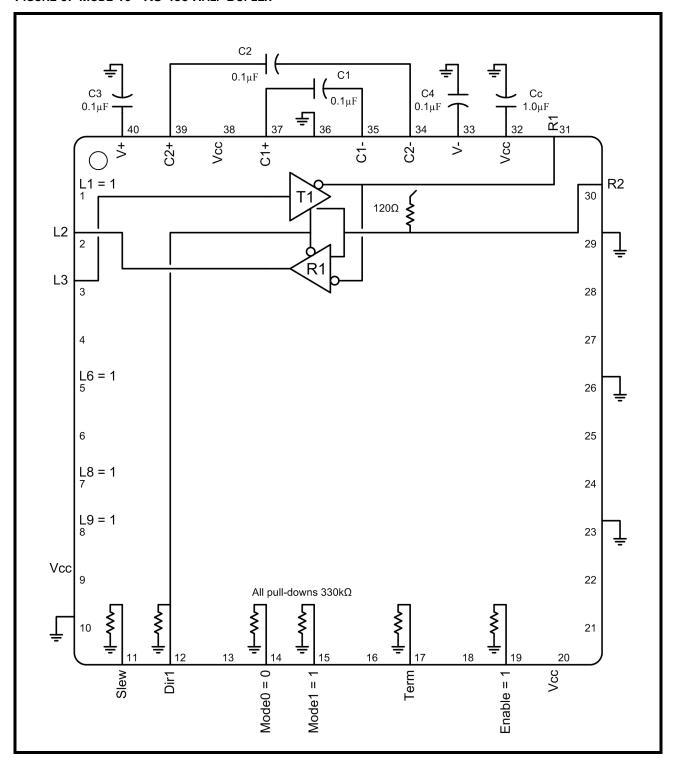
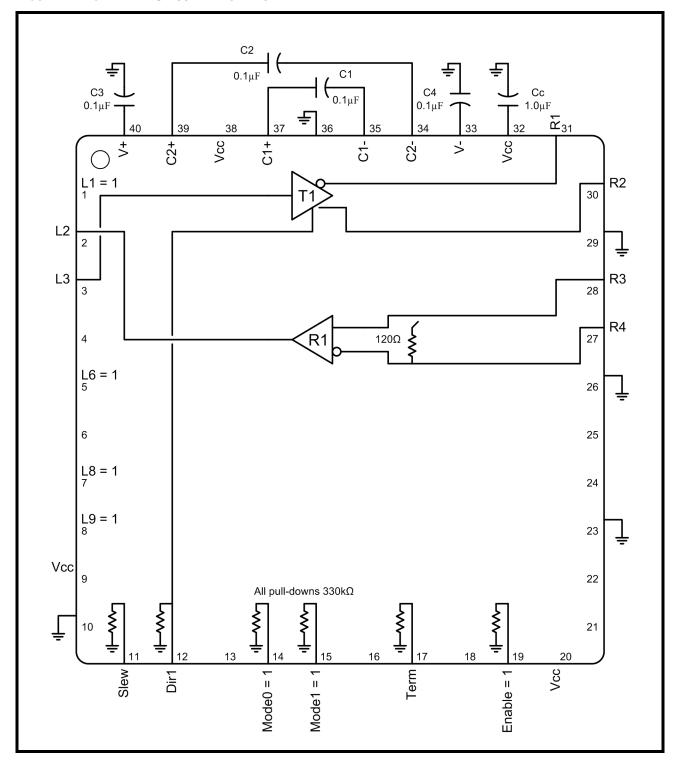




FIGURE 4. MODE 11 - RS-485/422 FULL DUPLEX





TEST FIXTURES

FIGURE 5. RS-485/422 RECEIVER TERMINATION RESISTANCE

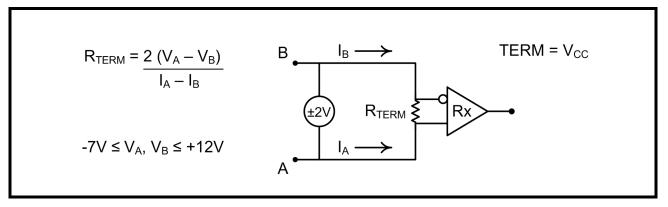


FIGURE 6. RS-485/422 DIFFERENTIAL DRIVER OUTPUT VOLTAGE

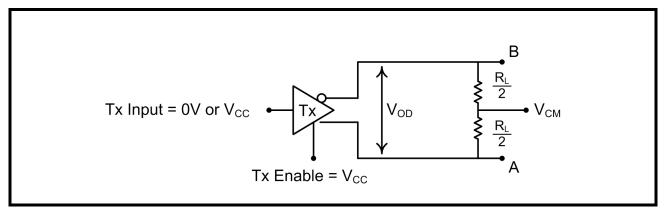


FIGURE 7. RS-485/422 DIFFERENTIAL DRIVER OUTPUT VOLTAGE OVER COMMON MODE

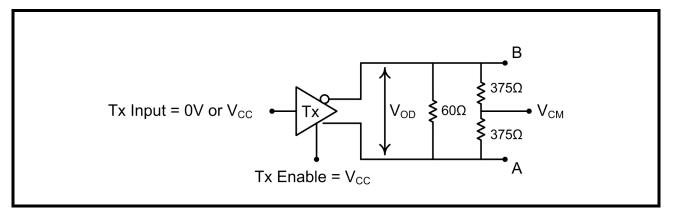




FIGURE 8. RS-485/422 DRIVER OUTPUT SHORT CIRCUIT CURRENT

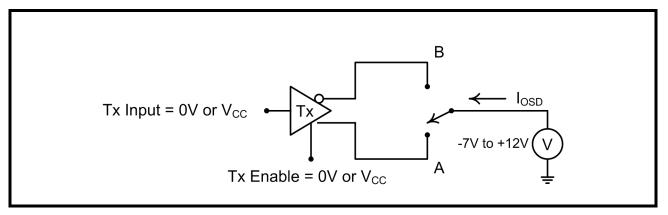


FIGURE 9. RS-232 RECEIVER PROPAGATION DELAY

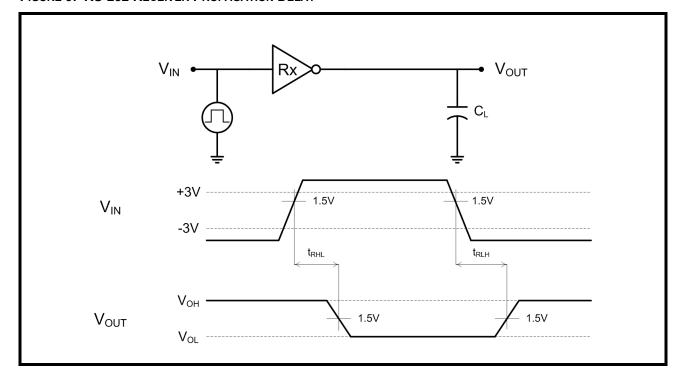




FIGURE 10. RS-232 DRIVER PROPAGATION DELAY

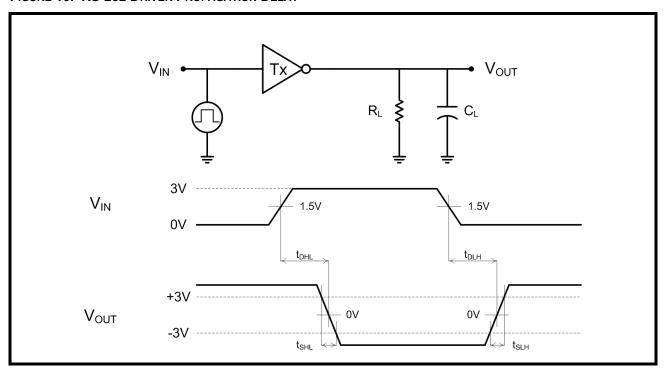


FIGURE 11. RS-485/422 RECEIVER PROPAGATION DELAY

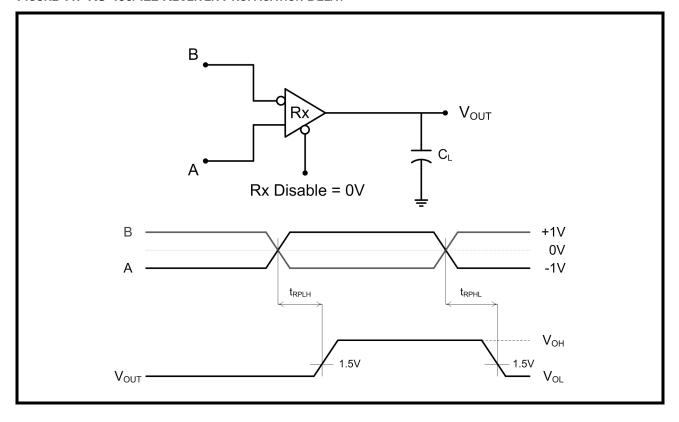




FIGURE 12. RS-485/422 DRIVER PROPAGATION DELAY AND RISE/FALL TIMES

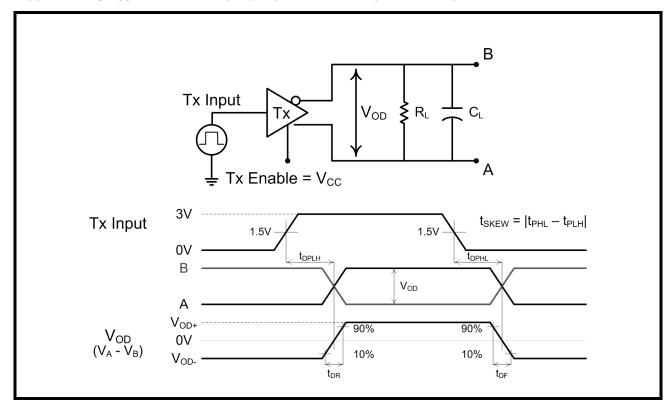


FIGURE 13. RS-485/422 RECEIVER OUTPUT ENABLE/DISABLE TIMES

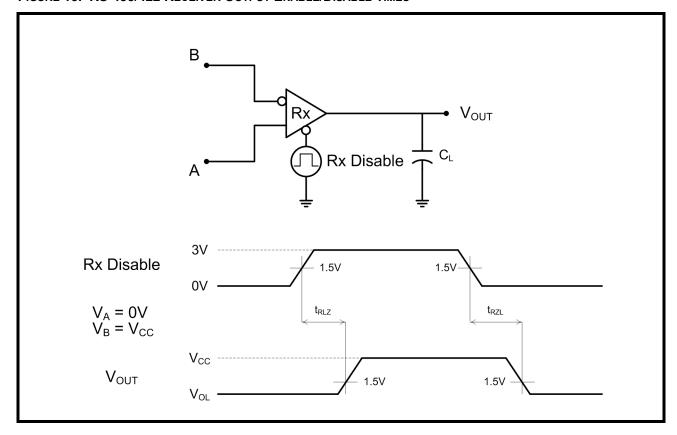
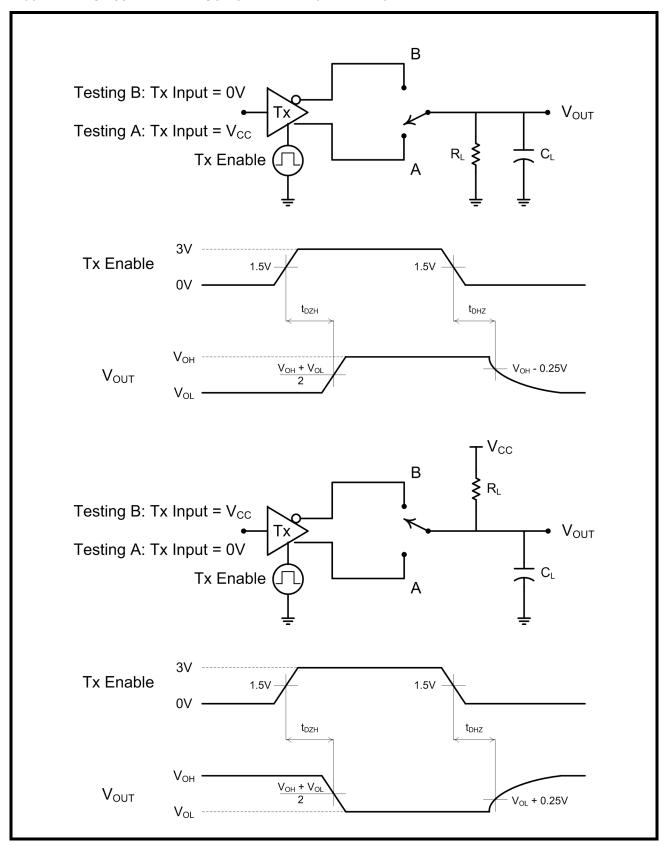




FIGURE 14. RS-485/422 DRIVER OUTPUT ENABLE/DISABLE TIMES



RS-232/RS-485/RS-422 TRANSCEIVER WITH INTERNAL TERMINATION

PRODUCT SUMMARY

The SP339 is an advanced multiprotocol transceiver supporting RS-232, RS-485, and RS-422 serial standards in a 40 pin QFN package. Integrated cable termination and four configuration modes allow all three protocols to be used interchangeably over a single cable or connector with no additional switching components. The RS-485/422 modes feature one driver and one receiver (1TX/1RX) in both half and full duplex configurations. The RS-232 mode (3TX/5RX) provides full support of all eight signals commonly used with the DB9 RS-232 connector. A dedicated mode is also available for diagnostic loopback testing.

INTERNALLY SWITCHED CABLE TERMINATION

Enabling and disabling the RS-485/422 termination resistor is one of the largest challenges system designers face when sharing a single connector or pair of lines across multiple serial protocols. A termination resistor may be necessary for accurate RS-485/422 communication, but must be removed when the lines are used for RS-232. SP339E provides an elegant solution to this problem by integrating the termination resistor and switching control, and allowing it to be switched in and out of the circuit with a single pin. No external switching components are required.

ENHANCED FAILSAFE

Ordinary RS-485 differential receivers will be in an indeterminate state whenever the data bus is not being actively driven. The enhanced failsafe feature of the SP339E guarantees a logic-high receiver output when the receiver inputs are open, shorted, or terminated but idle/undriven. The enhanced failsafe interprets 0V differential as a logic high with a minimum 50mV noise margin, while maintaining compliance with the EIA/TIA-485 standard of ±200mV. No external biasing resistors are required, further easing the usage of multiple protocols over a single connector.

±15kV ESD PROTECTION

ESD protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The bus pins (driver outputs and receiver inputs) have extra protection structures, which have been tested up to ±15kV without damage. These structures withstand high ESD in all states: normal operation, shutdown and powered down.

ESD protection is be tested in various ways. Exar uses the following methods to qualify the protection structures designed into SP339E:

- ±15kV using the Human Body Model (HBM)
- ±-8kV using IEC 61000-4-2 Contact Discharge

The IEC 61000-4-2 standard is more rigorous than HBM, resulting in lower voltage levels compared with HBM for the same level of ESD protection. Because IEC 61000-4-2 specifies a lower series resistance, the peak current is higher than HBM. The SP339E has passed both HBM and IEC 61000-4-2 testing without damage.

±20V FAULT TOLERANCE

All bus pins on the SP339E are protected against direct shorts or long term faults, up to ±20V. This allows the part to interoperate with legacy systems using ±15V RS-232 logic levels without damage or failure.

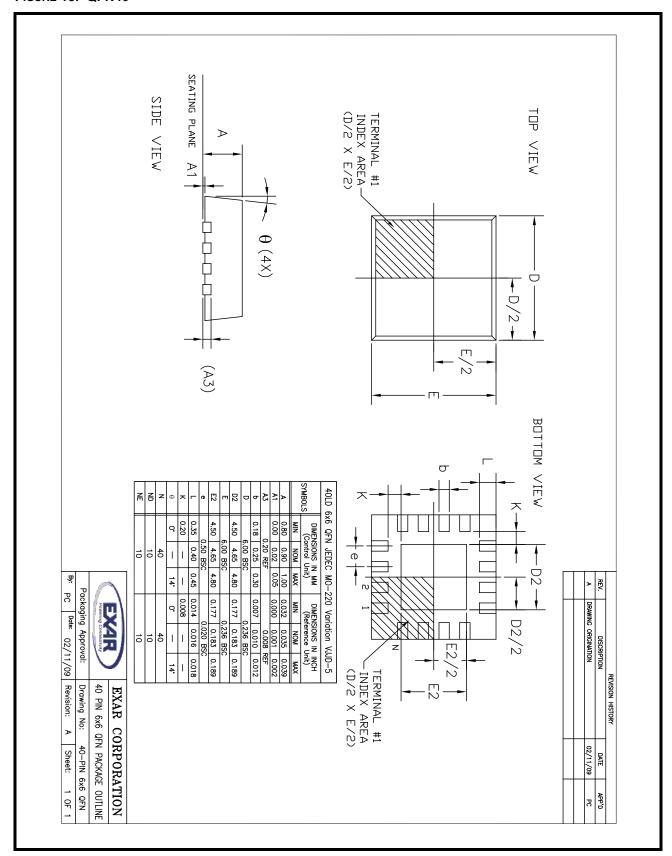
DIAGNOSTIC LOOPBACK MODE

The SP339E includes a diagnostic digital loop back mode for system testing as shown in Figure 1. The loopback mode connects the TTL driver inputs to the TTL receiver outputs, bypassing the analog driver and receiver circuitry. The analog/bus pins are internally disconnected in this mode.



PACKAGE DRAWINGS

FIGURE 15. QFN40







REVISION HISTORY

DATE	REVISION	DESCRIPTION
October 2011	1.0.0	Production Release

NOTICE

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